

BB02-UG: 3.96mm (0.156") HEADER, STRAIGHT, THROUGH HOLE, SINGLE ROW - 02 to 24 CONTACTS

SPECIFICATIONS

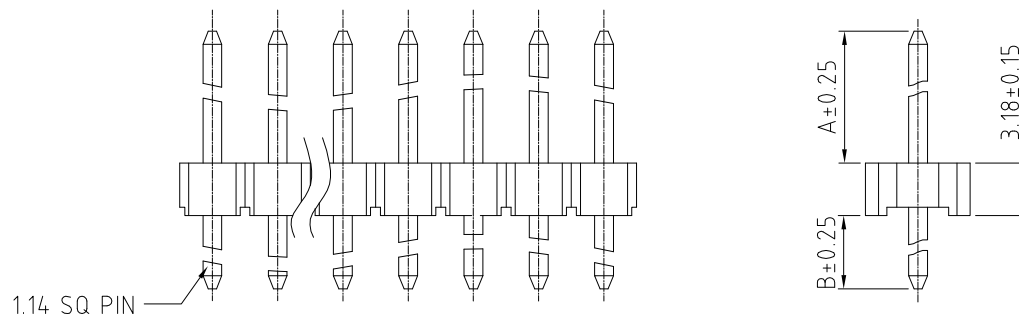
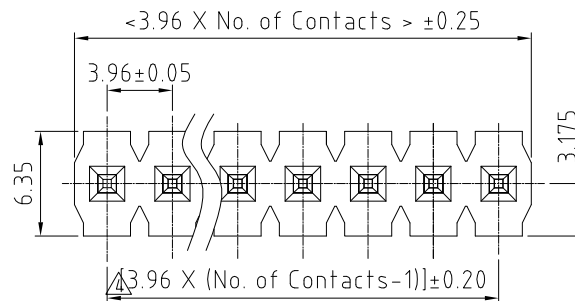
CURRENT RATING	7.9 AMP
INSULATOR RESISTANCE	5000 MEGOHMS MIN.
CONTACT RESISTANCE	20m ohms MAX.
DIELECTRIC WITHSTANDING	1500V AC/DC
OPERATING TEMPREATURE	-55°C TO +105°C
CONTACT MATERIAL	BRASS
INSULATOR MATERIAL	LCP, UL 94V-0
PLATING	MATT TIN OVER 30-50U" NICKEL
SOLDERABILITY	IR REFLOW: 280°C FOR 10 SEC WAVE: 250°C FOR 5-10 SEC MANUAL SOLDER: 380°C FOR 3-5 SEC

PACKAGE: BULK.

MATES WITH: - BB02-US
BB02-UT

NOTES:

1. GOLD FLASH PLATING IS AVAILABLE UPON REQUEST, PLEASE CONTACT US FOR MORE INFORMATION.



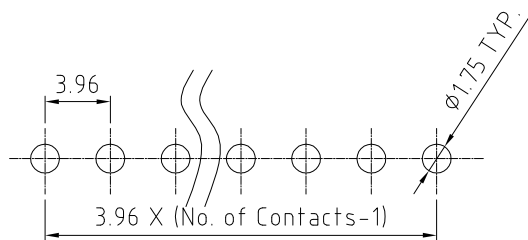
HOW TO ORDER



NO. OF CONTACTS
02 TO 24

CONTACT PLATING OPTIONS
M = MATT TIN (STANDARD)

- A: DIM. A=11.45, DIM. B=4.45
- B: DIM. A=12.70, DIM. B=4.45
- C: DIM. A=20.55, DIM. B=4.00
- D: DIM. A=3.80, DIM. B=12.10
- E: DIM. A=11.43, DIM. B=3.18
- △F: DIM. A=17.30, DIM. B=3.50
- △G: DIM. A=30.80, DIM. B=3.50



(TOLERANCE: ±0.05)
RECOMMENDED PC BOARD LAYOUT

REV.	DATE	BY
10.	15/06/01	CHC
11.	02/06/08	CHC
12.	25/07/08	NYW
13.	05/03/09	NYW
14.	31/07/09	CHC
15.	19/03/12	NYW

Scale:	3:1	THIRD ANGLE	Unstated Tolerances: X ± 0.30 .X ± 0.25 .XX ± 0.15 .XXX ± 0.10	Material	SEE NOTE
Drawn:	CHC				
App'd:	XXXX	Title	HEADER		NOT TO SCALE
Date:	19 MAR '12	Revision:	15	Unit:	mm

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Type:	BB02-UG
Drawing Number:	BB02-UG
Sheet	1 of 1
Drawing	© E and O E